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# INFORMATION DISCLOSURE STATEMENT BY APPLICANT

**(Use as many sheets as necessary)**

Sheet 1

of 1

**Complete if Known**

Application Number	10/609,339
Filing Date	June 26, 2003
First Named Inventor	Jarma Ilmari Maula
Art Unit	3753
Examiner Name	Kevin L. Lee
Attorney Docket Number	11429/13:3

## U. S. PATENT DOCUMENTS

[illegible]

## FOREIGN PATENT DOCUMENTS

[illegible]

**Examiner  
Signature**

Kevin Lee

Date Considered

10/27/05

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12/3/04

# ELECTRONIC INFORMATION DISCLOSURE STATEMENT

Electronic Version v18

Stylesheet Version v18.0

<b>Title of Invention</b>	<b>DIAPHRAGM VALVE WITH RELIABILITY ENHANCEMENTS FOR ATOMIC LAYER DEPOSITION</b>																														
<div style="display: flex; justify-content: space-between;"> <div> <p>Application Number : 10/609339</p> <p>Confirmation Number: 9277</p> <p>First Named Applicant: Jarmo Maula</p> <p>Attorney Docket Number: 11429/13:3</p> <p>Art Unit:</p> <p>Examiner:</p> <p>Search string: ( 5520001 or 6752387 or 20030121608 ).pn</p> </div> <div style="text-align: center;">  </div> </div>																															
<p><b>US Patent Documents</b></p> <p><b>Note: Applicant is not required to submit a paper copy of cited US Patent Documents</b></p> <table border="1" style="width: 100%; border-collapse: collapse; text-align: center;"> <thead> <tr> <th>init</th> <th>Cite.No.</th> <th>Patent No.</th> <th>Date</th> <th>Patentee</th> <th>Kind</th> <th>Class</th> <th>Subclass</th> </tr> </thead> <tbody> <tr> <td>KL</td> <td>1</td> <td>5520001</td> <td>1996-05-28</td> <td>Miyamoto et al.</td> <td></td> <td>62</td> <td>50.2</td> </tr> <tr> <td>KL</td> <td>2</td> <td>6752387</td> <td>2004-06-22</td> <td>Nishizato et al.</td> <td>B1</td> <td>261</td> <td>62</td> </tr> </tbody> </table>								init	Cite.No.	Patent No.	Date	Patentee	Kind	Class	Subclass	KL	1	5520001	1996-05-28	Miyamoto et al.		62	50.2	KL	2	6752387	2004-06-22	Nishizato et al.	B1	261	62
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